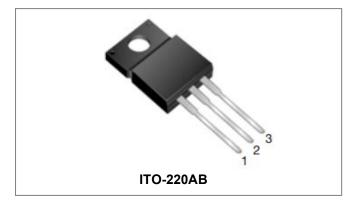


STF4060C(R)

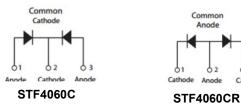
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STF4060C(R) SCHOTTKY RECTIFIER



Circuit Diagram



Features

- 150 °C T_J operation
- Ultralow forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Trench MOS Schottky technology
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	60	V
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @Tc=100°C, rectangular wave form	20(Per Leg) 40(Per Device)	А
Peak One Cycle Non-Repetitive Surge Current(Per Leg)	I _{FSM}	8.3ms, Half Sine pulse, Tc=25°C	240	А

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Cathode

Thermal-Mechanical Specifications:

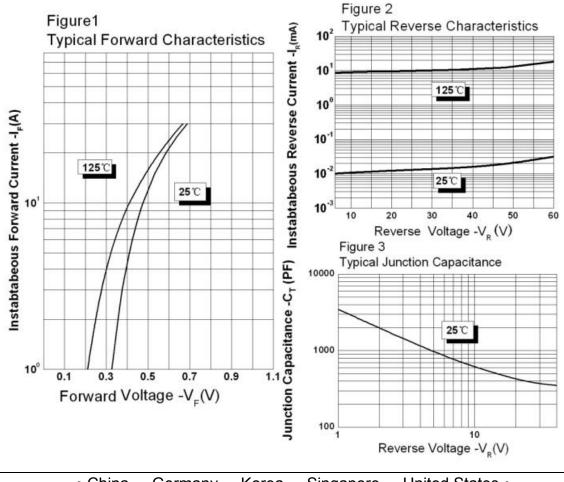
Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case(Per Leg)	R _{θJC}	DC operation	5	°C/W
Approximate Weight	wt	-	2	g
Case Style	ITO-220AB			

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop(Per Leg)*	V _{F1}	@ 10A, Pulse, TJ = 25℃	0.48	-	V
		@ 20A, Pulse, T」= 25℃	0.59	0.62	v
	VF2	@ 10A, Pulse, T」= 25℃	0.41	-	V
		@ 20A, Pulse, TJ=125℃	0.55	0.57	v
Reverse Current(Per Leg)*	I _{R1}	@V _R = rated V _R , T _J = 25° C	0.031	6	mA
	I _{R2}	@V _R = rated V _R , T _J = 125 $^{\circ}$ C	18.4	190	mA
Junction Capacitance	Ст	@V _R = 5V, T _C = 25 °C	949	_	pF
	0	f _{SIG} = 1MHz	343	_	рі
RSM Isolation Voltage		Clip mounting, the epoxy body away			
(t = 1.0 second, R. H. < =30%,		from the heatsink edge by more than	-	4500	
T _A = 25 °C)		0.110" along the lead direction.			
	V _{ISO}	Clip mounting, the epoxy body is	-	3500	V
		inside the heatsink.			
		Screw mounting, the epoxy body is	_	1500	
		inside the heatsink.			

* Pulse width < 300 µs, duty cycle < 2%

Ratings and Characteristics Curves



• China - Germany - Korea - Singapore - United States •

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STF4060C(R)

RoHS

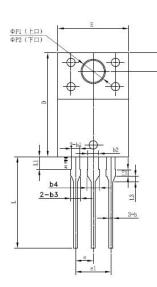


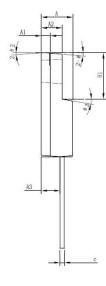
STF4060C(R)



Mechanical Dimensions ITO-220AB

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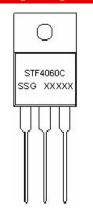




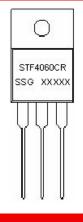
SYMBOL	Millimeters			
STWBOL	MIN.	TYP.	MAX.	
Α	4.30	4.50	4.70	
A1	1.10	1.30	1.50	
A2	2.80	3.00	3.20	
A3	2.50	2.70	2.90	
b	0.50	0.60	0.75	
b1	1.10	1.20	1.35	
b2	1.50	1.60	1.75	
b3	1.20	1.30	1.45	
b4	1.60	1.70	1.85	
С	0.50	0.60	0.75	
D	14.80	15.00	15.20	
<u> </u>	9.96	10.16	10.36	
е		2.55		
e1		5.10		
H1	6.50	6.70	6.90	
	12.70	13.20	13.70	
L1	1.60	1.80	2.00	
L2	0.80	1.00	1.20	
L3	0.60	0.80	1.00	
ΦP1(上□)	3.30	3.50	3.70	
ΦΡ2 (下口)	2.99	3.19	3.39	
Q	2.50	2.70	2.90	
Θ1		5°		
Θ2		4°		
Θ3		10°		
Θ4		5°		
Θ5		5°		



Marking Diagram



Tube Specification



Where XXXXX is YYWWL

ST	= Device	Туре

F	= Package type
40	= Forward Curre

- = Forward Current (40A)
- = Reverse Voltage (60V) = Configuration = SSG
- C(R) SSG

F

60

YY ww

1

= Year

= Week

= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

Ordering Information

Device	Package	Shipping
STF4060C(R)	ITO-220AB (Pb-Free)	50 pcs/ tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •
- 7mm 530mm 32mm

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